
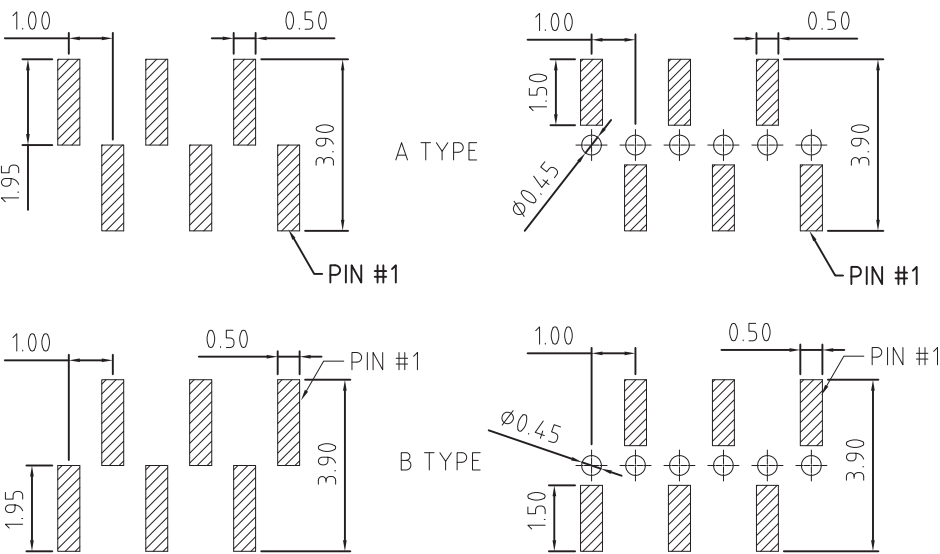


BB02-WE:- 1.00MM (0.039") SOCKET, SINGLE ROW, STRAIGHT, SMT TYPE, 02 TO 40 CONTACTS, DUAL ENTRY

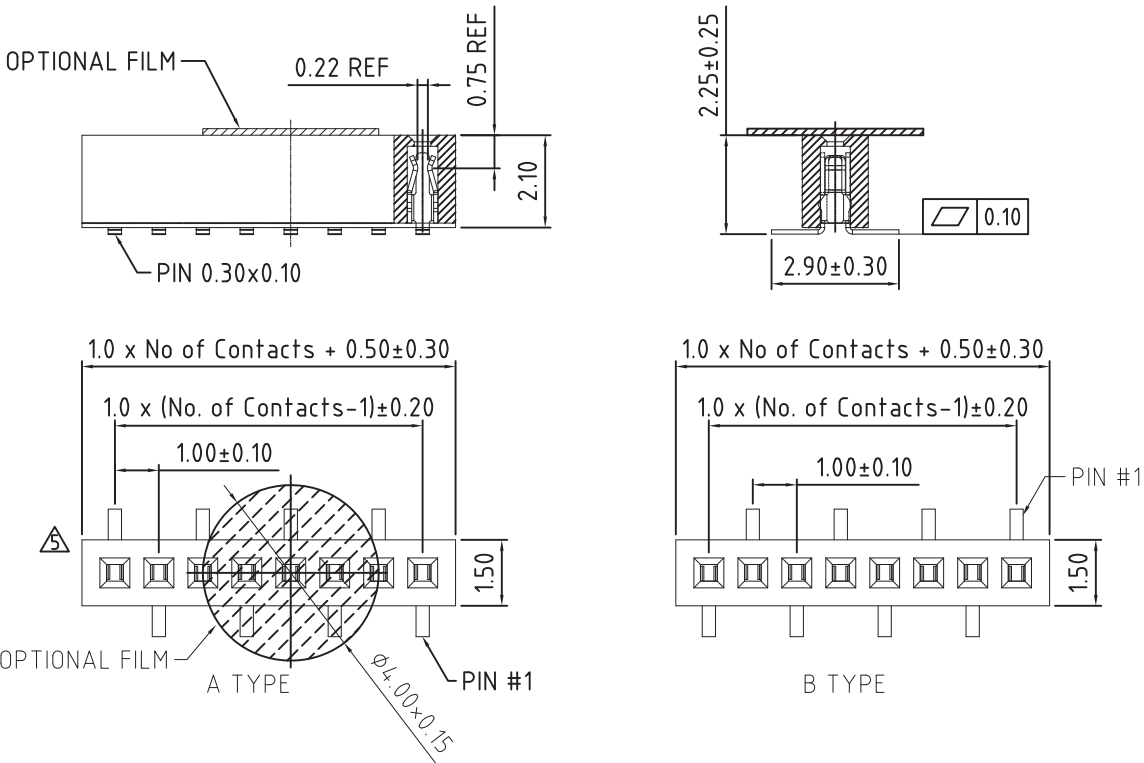
SPECIFICATIONS :
CURRENT RATING: 1.0AMP 
INSULATOR RESISTANCE: 1000 MEGOHMS MIN.
DIELECTRIC WITHSTANDING: AC 300 V
CONTACT RESISTANCE: 20m OHMS MAX.
OPERATING TEMPERATURE: -40°C TO +105°C
CONTACT MATERIAL: PHOSPHOR BRONZE
INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
STANDARD: LCP+30%GF
PLATING: GOLD OR TIN OVER 30-50U" NICKEL
SOLDERABILITY IR REFLOW: 280°C FOR 10 SEC
MANUAL SOLDER: 380°C FOR 3-5 SEC

NOTES:
1. RECOMMENDED MATING PIN LENGTH FOR TOP ENTRY: 1.5MM-1.8MM.

MATES WITH: - BB02-YJ BB02-YL BB02-YN
BB02-YK BB02-YM



TOP ENTRY TYPE (TOLERANCE: ±0.05) BOTTOM ENTRY TYPE
RECOMMENDED PCB LAYOUT



HOW TO ORDER

B	B	0	2	-	W	E	X	X	2	-	X	X	X	-	0	0	0	0	0	0
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NO. OF CONTACTS
02 to 40

CONTACT PLATING OPTIONS
K = GOLD FLASH (STANDARD)
A = 10U" GOLD ON CONTACT/GOLD FLASH ON TAIL
B = 15U" GOLD ON CONTACT/GOLD FLASH ON TAIL
T = BRIGHT TIN
M = MATT TIN

FOOTPRINT TYPE
A = A TYPE
B = B TYPE

PACKAGING OPTIONS
3 = TUBE
4 = TUBE + FILM
6 = T & R
7 = T & R + FILM